 CareerCross by JAC Recruitment

PR/158331 | Packaging Engineer

Job Information

Recruiter
JAC Recruitment Malaysia

Job ID
1507282

Industry
Other (Manufacturing)

Job Type
Permanent Full-time

Location
Malaysia

Salary
Negotiable, based on experience

Refreshed
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General Requirements

Minimum Experience Level
Over 3 years

Career Level
Mid Career

Minimum English Level
Business Level

Minimum Japanese Level
Business Level

Minimum Education Level
Associate Degree/Diploma

Visa Status
No permission to work in Japan required

Job Description

A US based equipment manufacturing company is looking for Packaging Engineer to responsible for designing, developing, and testing packaging solutions to ensure products are safely and efficiently packaged.

Job Responsibilities

- Collaborates with staff from manufacturing, Quality, Design, and shipping departments to optimize package design.

- Oversees the design of the finished product packaging & crating. Maintains knowledge base of customer specific crating or marking requirements

- Oversees the design of raw material to meet the technical requirements: Cleanroom compatibility etc…

- Tests packaging systems and components for new and existing products.

- Uses 3D modeling software to extract key design and weight requirements for packaging design.

- Researches and introduces prototype packaging suitable for Semiconductor capital equipment and respective components/ assemblies.

- Drafts specifications for new packing materials that will adequately protect finished products.

- Technical Interface with packaging suppliers (USA and Asia) who provide packaging material to the company and its suppliers.

- Working alongside new product development teams to identify specialty packaging needs.

- Maintains, updates and releases Cleanroom packaging and Crating specifications

- Point of contact for the company suppliers of packaging or require packaging designs be approved.

Job Requirement

- Extensive knowledge of packaging material and design as it applies to Cleanroom/ semiconductor equipment

- Bachelor's degree in Materials Engineering or related field required.

- At least 5 years of experience in package design preferred

- Capable in using Solidworks, Autocad or Creo

Company Description